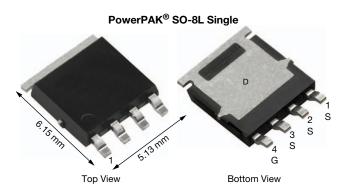


Vishay Siliconix

Automotive P-Channel 30 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY	
V _{DS} (V)	-30
$R_{DS(on)}$ (Ω) at V_{GS} = -10 V	0.0085
$R_{DS(on)}$ (Ω) at V_{GS} = -4.5 V	0.0200
I _D (A)	-30 ^a
Configuration	Single
Package	PowerPAK SO-8L



FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified d
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



FREE

P-Channel

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unless	s otherwise noted	(t		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	-30	V	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current ^a	T _C = 25 °C	L.	-30		
	T _C = 125 °C	Ι _D	-30		
Continuous Source Current (Diode Conduction) a		I _S	-30	А	
Pulsed Drain Current ^b		I _{DM}	-84		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	-32		
Single Pulse Avalanche Energy	L = 0.1 IIIH	E _{AS}	51	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	PD	68	W	
	T _C = 125 °C	гD	22	vv	
Operating Junction and Storage Temperature	Range	T _J , T _{stg}	-55 to +175	С°	
Soldering Recommendations (Peak Temperature) e, f			260	0	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	68	°C/W
Junction-to-Case (Drain)		R _{thJC}	2.2	0/10

Notes

- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR4 material).

f. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

1

os GO

a. Package limited.

d. Parametric verification ongoing.

e. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						1	<u> </u>
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	: 0 V, I _D = -250 μA	-30	-	-	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{DS} = V _{GS} , I _D = -250 μA		-2.0	-2.5	V
		V _{DS} =	0 V, $V_{GS} = \pm 12$ V	-	-	± 100	
Gate-Source Leakage	I _{GSS}	V _{DS} =	0 V, $V_{GS} = \pm 20 V$	-	-	± 300	nA
		$V_{GS} = 0 V$	V _{DS} = -30 V	-	-	-1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = -30V, T _J = 125 °C	-	-	-50	μA
		$V_{GS} = 0 V$	V _{DS} = -30V, T _J = 175 °C	-	-	-250	1
On-State Drain Current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} \le -5 V$	-30	-	-	Α
		$V_{GS} = -10 V$	I _D = -10 A	-	0.0070	0.0085	
Drain-Source On-State Resistance ^a	Б	$V_{GS} = -10 V$	I _D = -10 A, T _J = 125 °C	-	-	0.0130	Ω
Drain-Source On-State Resistance "	R _{DS(on)}	V _{GS} = -10 V	I _D = -10 A, T _J = 175 °C	-	-	0.0150	52
		$V_{GS} = -4.5 V$	I _D = -7 A	-	0.0120	0.0200	1
Forward Transconductance b	9 _{fs}	V _{DS} :	= -10 V, I _D = 10 A	-	32	-	S
Dynamic ^b							
Input Capacitance	C _{iss}			-	3400	4500	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = -15 V, f = 1 MHz	-	750	1000	pF
Reverse Transfer Capacitance	C _{rss}			-	580	770	
Total Gate Charge ^c	Qg			-	73	109	
Gate-Source Charge ^c	Q _{gs}	$V_{GS} = -10 V$	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	-	11	-	nC
Gate-Drain Charge ^c	Q _{gd}			-	21	-	
Gate Resistance	R _g		f = 1 MHz	1	2	3	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	20	25	
Rise Time ^c	t _r		-15 V, $R_L = 1.5 \Omega$	-	146	189	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -10 A$,	$V_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	57	75	ns
Fall Time ^c	t _f			-	20	25	
Source-Drain Diode Ratings and Chara	acteristics ^b						
Pulsed Current ^a	I _{SM}			-	-	-84	А
Forward Voltage	V _{SD}		-3 A, V _{GS} = 0 V	-	-0.75	-1.2	V

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

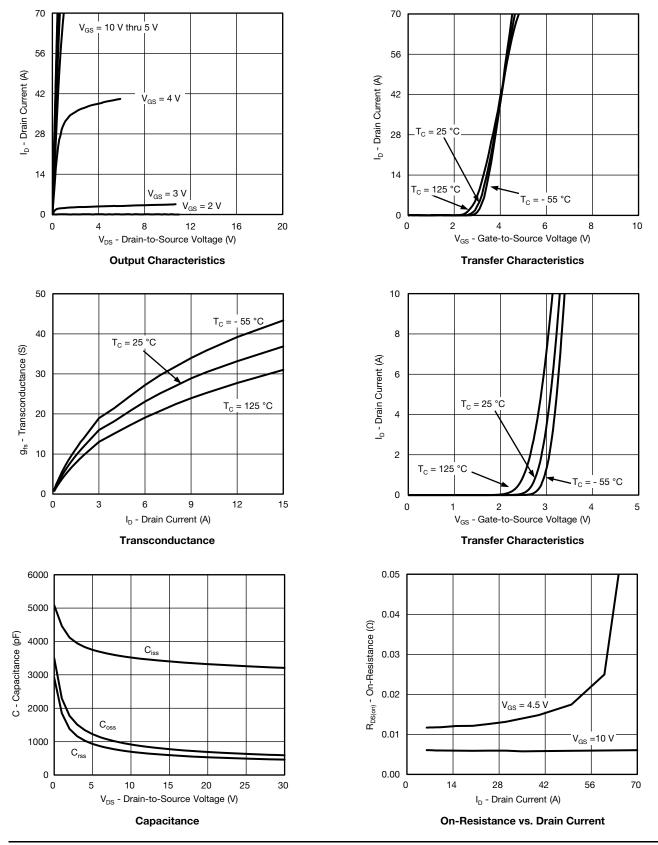
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



S15-2089-Rev. A, 31-Aug-15

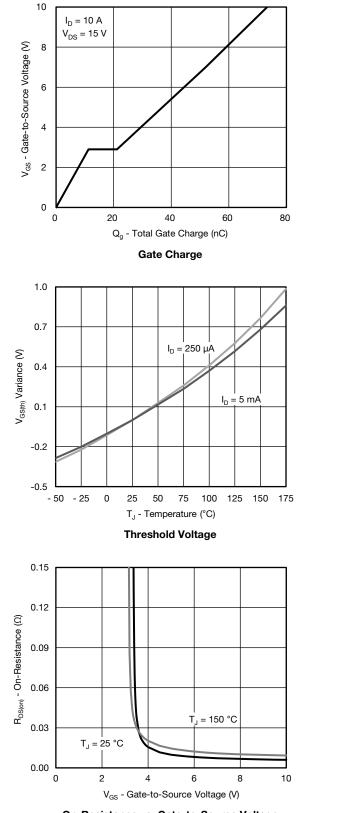
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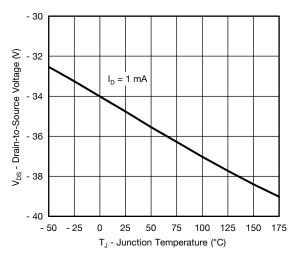
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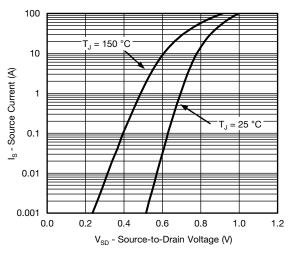
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



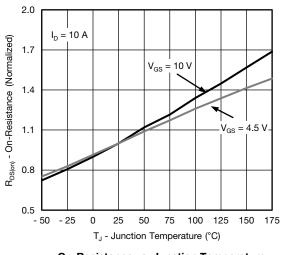
On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage



On-Resistance vs. Junction Temperature

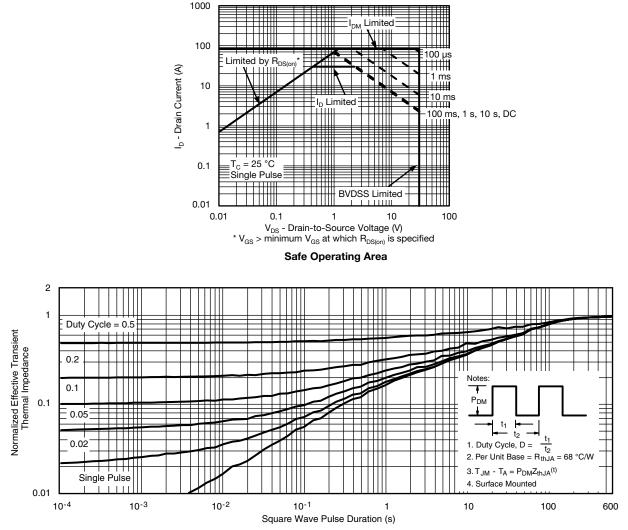
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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)

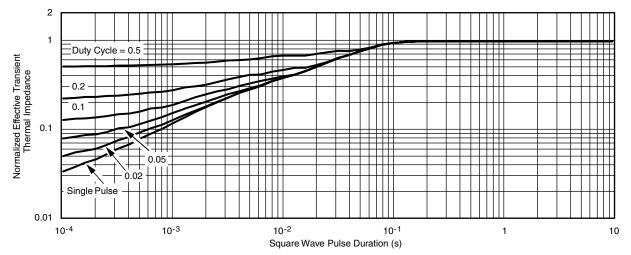


Normalized Thermal Transient Impedance, Junction-to-Ambient



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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

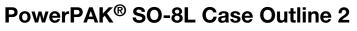
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

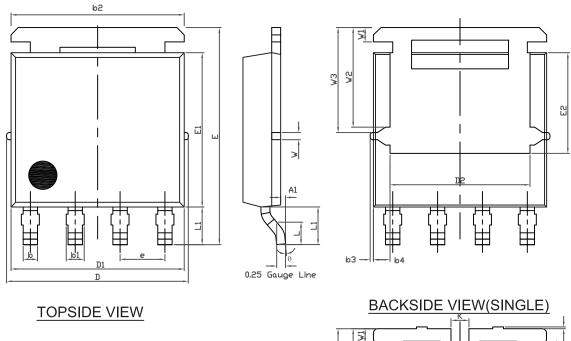
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

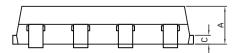
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

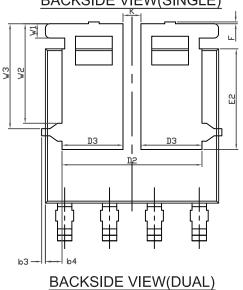
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67109.











Package Information



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DIM		MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094			0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
К		0.51			0.020		
W		0.23			0.009		
W1	0.41			0.016			
W2	2.82			0.111			
W3		2.96			0.117		
q	0°	-	10°	0°	-	10°	

Note

• Millimeters will gover



RECOMMENDED MINIMUM PAD FOR PowerPAK[®] SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12

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